

## EAST Search History

## EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	8	CLEAVER-MATTHEW\$. IN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:20
S2	4608580	mold\$3 or model\$3 or tool\$3 or cast\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:32
S3	4469540	adhesive or paste or glue or binder or resin or bonding	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:32
S4	9018516	cover\$3 or coat\$3 or encapsula\$1t\$3 or seal \$3 or envelop\$3 or surround\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:33
S5	5730898	layer\$3 or lamina\$4 or stack\$3 or multi\$1layer \$2 or lay\$1up or (lay\$3 up)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:33
S6	10802421	layer\$3 or lamina\$4 or stack\$3 or multi\$1layer \$2 or lay\$1up or (lay\$3 up) or sheet or block	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:38
S7	4608580	mold\$3 or model\$3 or tool\$3 or cast\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39

S8	4469540	adhesive or paste or glue or binder or resin or bonding	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39
S9	9018516	cover\$3 or coat\$3 or encapsula\$1t\$3 or seal \$3 or envelop\$3 or surround\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39
S10	133	HUNTSMAN\$.AS. and S7 and S8 and S9 and S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:39
S11	14	S10 and ("156".clas. or "264".clas.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 08:42
S12	204	264/642.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (mold \$3 or model\$3 or tool \$3 or cast\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:04
S13	162	S12 and (machin\$3 or grind\$3 or ground or abrad\$3 or abrasion or cut\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:05
S14	7	("4851061"   "5354414"   "5637169"   "5653925").PN. OR ("5948342").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:21
S15	9	(6077886 3861936 3652486 6060540 5942182 5707477 5773047 5859096).pn.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:39
S16	8	("3418695"   "4255364"   "4680216"   "4803108"   "5045575"   "5139843").PN. OR ("5707477").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:48

S17	13	("3418695"   "4255364"   "4620890"   "4680216"   "4803108"   "5045575"   "5071338"   "5139843"   "5344685"   "5387098").PN. OR ("5773047").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 09:50
S18	7	(EP-662380-\$ WO- 03051649-\$ EP- 365479-\$ EP-901849-\$  WO-02020261-\$).did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:55
S19	204	264/642.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (mold \$3 or model\$3 or tool \$3 or cast\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:57
S20	77	264/643.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (mold or model\$3 or tool\$3 or cast) not S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 09:57
S21	941	264/219.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:03
S22	135	S21 and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:04

S23	46	264/220.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM) not S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:18
S24	21	156/153.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM) not S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:22
S25	21	156/154.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform)) not S24	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:25

S26	58	156/278.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:30
S27	45	156/280.ccls. and (adhesive or paste or glue or binder or resin or bonding) and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform)) not S26	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:34
S28	187	156/295.ccls. and (layer \$3 or lamina\$4 or stack \$3 or multi\$1layer\$2 or lay\$1up or (lay\$3 up) or sheet or block) and (mold or model or tool)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:37
S29	13	S28 and ((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 10:38

S30	72	("2750632"   "2822448"   "3153915"   "3231341"   "3292894"   "3386503"   "3410936"   "3464854"   "3607569"   "3622659"   "3635623"   "3645899"   "3838094"   "3895162"   "3904555"   "4038444"   "4049767"   "4073049"   "4102851"   "4105184"   "4125351"   "4146565"   "4287115"   "4307147"   "4356233"   "4366185"   "4375498"   "4394340"   "4423094"   "4459335"   "4528305"   "4533685"   "4546674"   "4601867"   "4654382"   "4670485"   "4681904"   "4732962"   "4830779"   "4859528"   "4920161"   "4925886"   "4940629"   "4980112"   "5053476"   "5057256"   "5073589"   "5096762"   "5202753"   "5226210"   "5261993"   "5281634"   "5298548"   "5302107"   "5319003"   "5358211"   "5470651"   "5691402"   "5746966"   "5783259"   "5832981").PN. OR ("6309587").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/10/21 10:43
S31	67	epoxy with (dynamic viscosity)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/10/21 17:09

S32	17	("4349651"   "4358571"   "4420605"   "4423094"   "4430445"   "4528305"   "4659779"   "4689388"   "4701378"   "4732962"   "4742148"   "4925886"   "4933392"   "5280053"   "5691402").PN. OR ("6060540").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/11/13 11:13
S33	9	CLEAVER-MATTHEWS. IN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 11:31
S34	93	HUNTSMAN\$.AS. and (layer\$3 or lamina\$4 or stack\$3 or multi\$1layer \$2 or lay\$1up or (lay\$3 up) or sheet or block) and (mold\$3 or mould \$3 or model\$3 or tool \$3 or cast\$3) and (adhesive or paste or glue or binder or resin or bonding or cement or epoxy) and (cover\$3 or coat\$3 or encapsulat \$3 or encapsulant or seal\$3 or envelop\$3 or surround\$3) and (machin\$3 or grind\$3 or ground or abrad\$3 or abrasion or cut\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 11:41
S35	10	S34 and ((layer\$3 or lamina\$4 or stack\$3 or multi\$1layer\$2 or lay \$1up or (lay\$3 up) or sheet or block) with (mold\$3 or mould\$3 or model\$3 or tool\$3 or cast\$3)) and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) same (cover \$3 or coat\$3 or encapsulat\$3 or encapsulant or seal\$3 or envelop\$3 or surround\$3) same (machin\$3 or grind\$3 or ground or abrad\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 11:42

		or abrasion or cut\$4))				
S36	26	156/153.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:06



S37	14	156/154.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not S36	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:08
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S38	5	156/244.12.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:11
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S39	25	156/278.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:12
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S40	25	156/280.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:17
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S41	4	<p>264/642.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39 or S40)</p>	<p>US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB</p>	ADJ	ON	<p>2009/11/13 13:28</p>
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S42	2	264/643.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39 or S40)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:29
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S43	43	264/219.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39 or S40)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:29
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S44	18	264/220.ccls. and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat \$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post \$1curing or post \$1harden or post \$1hardens or post \$1hardened or post \$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39 or S40 or S43)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 13:42
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S45	12	<p>264/221.ccls. and          ((adhesive or paste or          glue or binder or resin          or bonding or cement          or epoxy) with (layer          or layered or layering          or lamina or laminate          or laminated or          laminating or stack or          stacked or stacking or          multilayer or          multilayered or layup          or (lay up) or (layered          up) or (laying up) or          sheet or block) with          (mold or mould or          molding or moulding or          form or tool or tooling          or model or modeling))          and ((cover\$3 or coat          \$3 or encapsula\$1t\$3          or seal\$3 or envelop\$3          or surround\$3) with          (adhesive or paste or          glue or binder or resin          or bonding or cement          or epoxy)) and ((cure          or cured or curing or          harden or hardened or          hardening or set or          setting) with (ambient          or ((room or normal)          near2 temperature)))          and (thermocure or          thermocured or          thermocuring or          thermoset or          thermosetting or post          \$1cure or post\$1cures          or post\$1cured or post          \$1curing or post          \$1harden or post          \$1hardens or post          \$1hardened or post          \$1hardening or ((latent          or latency or latently or          hot or heat or heated          or heating or          temperature or second          or additional or final)          with (cure or cured or          curing or harden or          hardened or hardening          or set or setting))) not          (S36 or S37 or S38 or          S39 or S40 or S43 or          S44)</p>	<p>US-PGPUB;          USPAT; USOCR;          FPRS; EPO;          JPO;          DERWENT;          IBM_TDB</p>	ADJ	ON	<p>2009/11/13          13:45</p>
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S46	241	("0408677"   "0460377"   "1164987"   "20010031531"   "20010034114"   "20020093115"   "20020149137"   "20020181647"   "20030128812"   "20030128813"   "20040006405"   "20040128016"   "20050206048"   "20070036844"   "20070158014"   "3379812"   "3676541"   "3829536"   "3964534"   "4288697"   "4355400"   "4356400"   "4465540"   "4748328"   "4801379"   "4812236"   "4825646"   "4856043"   "4915757"   "4951305"   "5002889"   "5017317"   "5043043"   "5088047"   "5126529"   "5127037"   "5147761"   "5150183"   "5183598"   "5190637"   "5192559"   "5203944"   "5206983"   "5207371"   "5208431"   "5216616"   "5252881"   "5286573"   "5301863"   "5306447"   "5348693"   "5378583"   "5398193"   "5447068"   "5450183"   "5450751"   "5459320"   "5483387"   "5514232"   "5551904"   "5555481"   "5559708"   "5576147"   "5596504"   "5606589"   "5620854"   "5637169"   "5638212"   "5644177"   "5681661"   "5692507"   "5702384"   "5718618"   "5721687"   "5729585"   "5763318"   "5773116"   "5778468"   "5786597"   "5795748"	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/11/13 14:43
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"5879489"	
"5902538"	"5924277"
"5925308"	
"5929446"	"5932940"
"5949850"	
"5955801"	"5955818"
"5962949"	
"5963788"	"5985204"
"5994801"	
"5994816"	"5998260"
"6004500"	
"6007765"	"6011265"
"6014419"	
"6017410"	"6018422"
"6018566"	
"6018680"	"6021358"
"6055899"	
"6068684"	"6075840"
"6084626"	
"6084980"	"6088102"
"6124663"	
"6126775"	"6133670"
"6134294"	
"6149160")	.PN. OR
("6152181"	
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"6165406"	
"6175615"	"6179601"
"6185278"	
"6188743"	"6190594"
"6193923"	
"6197180"	"6210644"
"6219015"	
"6226120"	"6230408"
"6241934"	
"6242163"	"6245184"
"6245249"	
"6245487"	"6245849"
"6250070"	
"6252938"	"6261066"
"6261506"	
"6270335"	"6276313"
"6280090"	
"6299300"	"6307815"
"6310419"	
"6314887"	"6318069"
"6318849"	
"6324748"	"6328903"
"6333584"	
"6336318"	"6338199"
"6338249"	
"6340222"	"6344392"
"6346030"	

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	"6360424"	
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	"6367911"	
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	"6395126"	
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	"6397793"	
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	"6401004"	
"6404942"		"6406658"
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	"6454945"	
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	"6627030"	
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	"6682688"	
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	"6829536"	
"6881950"		"7057245"
	"7077638"	
"7141080"		"7170140"
	"7203569"	
"7235166"		
"7252861")	.PN. OR	
("7410606")	.URPN.	

S47	6	S46 and ((cover\$3 or coat\$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with epoxy) and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post\$1cure or post\$1cures or post\$1cured or post\$1curing or post\$1harden or post\$1hardens or post\$1hardened or post\$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting))) not (S36 or S37 or S38 or S39 or S40 or S43 or S44 or S45)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 14:53
S48	12	("4048709"   "4073049"   "4086118"   "4466936"   "4601867"   "4834929"   "4925611"   "4929403"   "5120480"   "5213747"   "5215699"   "5904986").PN. OR ("6352609").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/11/13 14:54

S49	13525	((rapid prototyp\$3) or stereolithograph\$2 or (sheet laminat\$3) or (sheet mold\$3) or (building block) or SMP or (seamless model\$3) or (laminated object) or LOM or (solid freeform) or (size near2 (cast or casting))) and ((adhesive or paste or glue or binder or resin or bonding or cement or epoxy) with (layer or layered or layering or lamina or laminate or laminated or laminating or stack or stacked or stacking or multilayer or multilayered or layup or (lay up) or (layered up) or (laying up) or sheet or block) with (mold or mould or molding or moulding or form or tool or tooling or model or modeling)) and ((cover\$3 or coat\$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) not (S36 or S37 or S38 or S39 or S40 or S43 or S44 or S45 or S47 or S48)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:01
S50	2317	S49 and (((cover\$3 or coat\$3 or encapsula\$1t\$3 or seal\$3 or envelop\$3 or surround\$3) with (adhesive or paste or glue or binder or resin or bonding or cement or epoxy)) same (machine or machined or machining or grind or grinding or ground or abrade or abraded or abrading or abrasion or CNC or numeric or numerical or numerically))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:03

S51	252	S50 and ((cure or cured or curing or harden or hardened or hardening or set or setting) with (ambient or ((room or normal) near2 temperature))) and (thermocure or thermocured or thermocuring or thermoset or thermosetting or post \$1cure or post\$1cures or post\$1cured or post\$1curing or post\$1harden or post\$1hardens or post\$1hardened or post\$1hardening or ((latent or latency or latently or hot or heat or heated or heating or temperature or second or additional or final) with (cure or cured or curing or harden or hardened or hardening or set or setting)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:04
S52	32	S51 and "156".clas.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:04
S53	192	S51 and epoxy	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:05
S54	40	S51 and "264".clas.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:08
S55	12	("5330343"   "5651806"   "5906667"   "6021358"   "6116888"   "6192327").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/11/13 15:11

12/ 7/ 2009 9:47:07 AM

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